

Pages 1 to 13

# TRANSISTORS, HIGH POWER, NPN

# **BASED ON TYPE 2N5672**

ESCC Detail Specification No. 5203/004

Issue 2 February 2008





ISSUE 2

### LEGAL DISCLAIMER AND COPYRIGHT

European Space Agency, Copyright © 2008. All rights reserved.

The European Space Agency disclaims any liability or responsibility, to any person or entity, with respect to any loss or damage caused, or alleged to be caused, directly or indirectly by the use and application of this ESCC publication.

This publication, without the prior permission of the European Space Agency and provided that it is not used for a commercial purpose, may be:

- copied in whole, in any medium, without alteration or modification.
- copied in part, in any medium, provided that the ESCC document identification, comprising the ESCC symbol, document number and document issue, is removed.



ISSUE 2

# **DOCUMENTATION CHANGE NOTICE**

(Refer to https://escies.org for ESCC DCR content)

DCR No.	CHANGE DESCRIPTION
187, 331	Specification up issued to incorporate editorial and technical changes per DCR.



PAGE 4





# TABLE OF CONTENTS

<u>1.</u>	GENERAL	<u>5</u>
1.1	Scope	5
1.2	Applicable Documents	5
1.3	Terms, Definitions, Abbreviations, Symbols and Units	5
1.4	The ESCC Component Number and Component Type Variants	5
1.4.1	The ESCC Component Number	5
1.4.2	Component Type Variants	5
1.5	Maximum Ratings	5
1.6	Physical Dimensions and Terminal Identification	6
1.7	Functional Diagram	7
1.8	Materials and Finishes	7
<u>2.</u>	REQUIREMENTS	<u>8</u>
2.1	General	8
2.1.1	Deviations from the Generic Specification	8
2.1.1.1	Deviation from Screening Tests - Chart F3	8
2.2	Marking	8
2.3	Terminal Strength	8
2.4	Electrical Measurements at Room, High and Low Temperatures	8
2.4.1	Room Temperature Electrical Measurements	8
2.4.2	High and Low Temperatures Electrical Measurements	11
2.5	Parameter Drift Values	11
2.6	Intermediate and End-Point Electrical Measurements	12
2.7	Power Burn-in Conditions	12
2.8	Operating Life Conditions	12
APPENDI	X 'A'	13



#### 1. GENERAL

#### 1.1 SCOPE

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

#### 1.2 APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:

- (a) ESCC Generic Specification No. 5000
- (b) MIL-STD-750, Test Methods and Procedures for Semiconductor Devices

#### 1.3 TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

#### 1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

### 1.4.1 <u>The ESCC Component Number</u>

The ESCC Component Number shall be constituted as follows:

Example: 520300401

Detail Specification Reference: 5203004

Component Type Variant Number: 01 (as required)

### 1.4.2 <u>Component Type Variants</u>

The component type variants applicable to this specification are as follows:

Variant Number	Based on Type	Case	Lead/Terminal Material and Finish	Weight max g
01	2N5672	TO-3	D2	18
02	2N5672	TO-3	H7	18
03	2N5672	TO-3	H9	18

The lead/terminal material and finish shall be in accordance with the requirements of ESCC Basic Specification No. 23500.

### 1.5 <u>MAXIMUM RATINGS</u>

The maximum ratings shall not be exceeded at any time during use or storage.

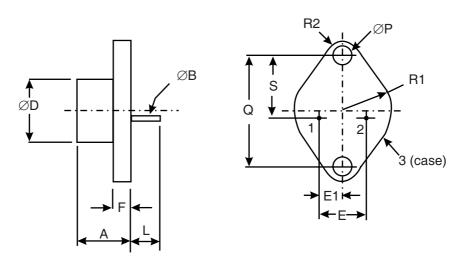
Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC Generic Specification.



Characteristics	Symbols	Maximum Ratings	Unit	Remarks
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	150	V	Over T <sub>op</sub>
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	120	V	Over T <sub>op</sub>
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	7	V	Over T <sub>op</sub>
Collector Current	I <sub>C</sub>	30	Α	
Base Current	I <sub>B</sub>	10	Α	
Power Dissipation	P <sub>tot</sub>	140	W	At T <sub>case</sub> ≤ +25°C Note 1
Operating Temperature Range	T <sub>op</sub>	-65 to +200	°C	Note 2
Storage Temperature Range	T <sub>stg</sub>	-65 to +200	°C	Note 2
Soldering Temperature	T <sub>sol</sub>	+260	°C	Note 3

- For T<sub>case</sub> > +25°C, derate linearly to 0W at +200°C.
  For Variants with tin-lead plating or hot solder dip lead finish all testing performed at T<sub>amb</sub> > +125°C shall be carried out in a 100% inert atmosphere.
- Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the same lead shall not be resoldered until 3 minutes have elapsed.

#### 1.6 PHYSICAL DIMENSIONS AND TERMINAL IDENTIFICATION Metal Flange Mount Package (TO-3) - 2 lead



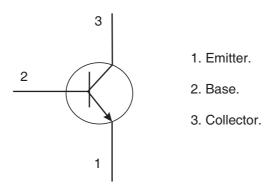
Symbols	Dimension	Notes	
Symbols	Min	Max	Notes
Α	6.35	11.43	
ØB	0.97	1.09	2
ØD	-	22.23	



Symbols	Dimension	Notes	
Symbols	Min	Max	Notes
E	10.67	11.18	
E1	5.21	5.72	
F	1.27	3.43	
L	7.92	-	
ØP	3.84	4.09	3
Q	29.9	30.4	
R1	12.57	13.34	
R2	3.33	4.78	
S	16.54	17.15	

- 1. Terminal identification is specified by the component's geometry where Lead 1 = emitter, Lead 2 = base and Terminal 3 (case) = collector.
- 2. Applies to both leads.
- 3. Applies to both mounting holes.

# 1.7 <u>FUNCTIONAL DIAGRAM</u>



#### NOTES:

1. The collector is internally connected to the case.

# 1.8 <u>MATERIALS AND FINISHES</u>

Materials and finishes shall be as follows:

- a) Case
  - The case shall be hermetically sealed and have a metal body with hard glass seals.
- b) Leads/Terminals

As specified in Component Type Variants.



#### 2. REQUIREMENTS

#### 2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the ESCC Generic Specification. Permitted deviations from the Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the Generic Specification and this Detail Specification, formally agreed with specific Manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

### 2.1.1 Deviations from the Generic Specification

### 2.1.1.1 Deviation from Screening Tests - Chart F3

High Temperature Reverse Bias Burn-in and the subsequent Final Measurements for HTRB shall be omitted.

#### 2.2 MARKING

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 21700 and as follows.

The information to be marked on the component shall be:

- (a) The ESCC qualified components symbol (for ESCC qualified components only).
- (b) The ESCC Component Number.
- (c) Traceability information.

### 2.3 <u>TERMINAL STRENGTH</u>

The test conditions for terminal strength, tested as specified in the ESCC Generic Specification, shall be as follows:

Test condition A, tension, with an applied force of 10N for a duration of 10s.

### 2.4 <u>ELECTRICAL MEASUREMENTS AT ROOM, HIGH AND LOW TEMPERATURES</u>

Electrical measurements shall be performed at room, high and low temperatures.

# 2.4.1 Room Temperature Electrical Measurements

The measurements shall be performed at  $T_{amb}$ =+22 ±3°C.





Characteristics	Symbols	MIL-STD-750		Limits		Units
		Test Method		Min	Max	
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	3011	I <sub>C</sub> = 200mA Bias condition D Note 1	120	-	V
	V <sub>(BR)CEX</sub>	3011	I <sub>C</sub> = 200mA V <sub>BE</sub> =-1.5V Bias condition C	150	-	V
	V <sub>(BR)CER</sub>	3011	$I_C = 200 \text{mA}$ $R_{BE} = 50 \Omega$ Bias condition B	140	-	V
Collector-Emitter Cut-off Current	I <sub>CEX</sub>	3041	V <sub>CE</sub> =135V V <sub>BE</sub> =-1.5V Bias condition A	-	10	mA
	I <sub>CEO</sub>	3041	V <sub>CE</sub> =80V Bias condition D	-	10	mA
Emitter-Base Cut- off Current	I <sub>EBO</sub>	3061	V <sub>EB</sub> =7V Bias condition D	-	10	mA
Forward-Current Transfer Ratio	h <sub>FE1</sub>	3076	V <sub>CE</sub> =5V ; I <sub>C</sub> =20A Note 1	20	-	-
	h <sub>FE2</sub>	3076	V <sub>CE</sub> =2V ; I <sub>C</sub> =15A Note 1	20	100	-
Base-Emitter Voltage	V <sub>BE</sub>	3020	I <sub>C</sub> =15A V <sub>CE</sub> =5V Note 1	-	1.6	V
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	3071	I <sub>C</sub> =15A I <sub>B</sub> =1.2A Note 1	-	750	mV
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	3066	I <sub>C</sub> =15A I <sub>B</sub> =1.2A Test condition A Note 1	-	1.5	V
Magnitude of Small-Signal Short-Circuit Forward-Current Transfer Ratio	lh <sub>fe</sub> l	3306	V <sub>CE</sub> =10V, I <sub>C</sub> =2A f=5MHz Note 2	10	-	-
Output Capacitance	C <sub>obo</sub>	3236	V <sub>CB</sub> =10V, I <sub>E</sub> =0A f=1MHz Note 2	-	900	pF

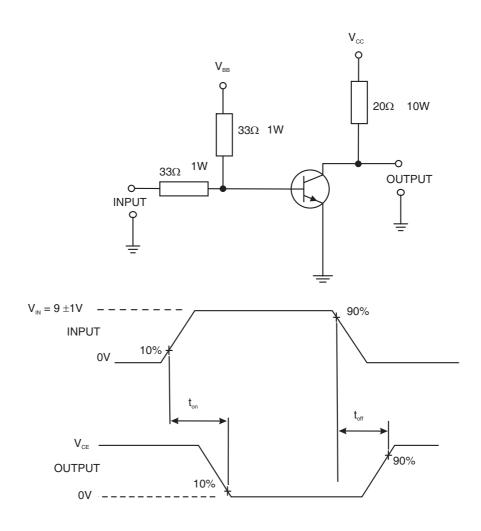




Characteristics	Symbols		Test Conditions	Limits		Units
		Test Method		Min	Max	
Turn-on Time	t <sub>on</sub>	3251	$\begin{array}{c} I_{C}{=}15A, \\ I_{B1}{=}1.2A \\ I_{B2}{=}1.2A \\ V_{CC}{=}30\pm\!2V \\ V_{BB}{=}4\pm1V \\ V_{IN}{=}9\pm\!1V \\ Test condition A \\ Notes 2, 3 \end{array}$	-	500	ns
Turn-off Time	t <sub>off</sub>	3251	$\begin{array}{c} I_{C}{=}15A, \\ I_{B1}{=}1.2A \\ I_{B2}{=}1.2A \\ V_{CC}{=}30~\pm 2V \\ V_{BB}{=}4~\pm 1V \\ V_{IN}{=}9~\pm 1V \\ Test~condition~A \\ Notes~2,~3 \end{array}$	-	1.5	μѕ

- 1. Pulsed measurement: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
- 2. For AC characteristics read and record measurements shall be performed on a sample of 32 components with 0 failures allowed. Alternatively a 100% inspection may be performed.
- 3.  $t_{on}$  and  $t_{off}$  shall be measured using the following test circuit. The input waveform shall be supplied by a pulse generator with the following characteristics:  $t_r$ = $t_f$   $\leq$  20ns, Pulse Width = 20 $\mu$ s, Duty Cycle = 2%. The output sampling oscilloscope shall have the characteristics  $Z_{IN} \geq$  100 $\mu$ 0,  $Z_{IN} \leq$  50pF and  $Z_{IN} \leq$  20ns. Adjustment of  $Z_{IN} \leq$  100 made with a suitable current probe to achieve the specified  $Z_{IN} \leq$  100 made  $Z_{IN} \leq$  100 made Z





### 2.4.2 High and Low Temperatures Electrical Measurements

Characteristics	- ,	Test Conditions	Limits		Units	
		Test Method	Note 1	Min	Max	
Collector-Emitter Cut-off Current	I <sub>CEX</sub>	3041	$T_{case}$ =+150(+0 -5) $^{o}$ C $V_{CE}$ = 100V $V_{BE}$ =-1.5V Bias condition A	-	10	mA

## **NOTES:**

1. Read and record measurements shall be performed on a sample of 5 components with 0 failures allowed. Alternatively a 100% inspection may be performed.

# 2.5 PARAMETER DRIFT VALUES

Unless otherwise specified, the measurements shall be performed at  $T_{amb}$ =+22 ±3°C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The drift values ( $\Delta$ ) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.



Characteristics	Symbols		Units		
		Drift	Absolute		
		Value Δ	Min	Max	
Collector-Emitter Cut-off Current	I <sub>CEO</sub>	±500 or (1) ±100%	-	10000	μΑ
Forward-Current Transfer Ratio 2	h <sub>FE2</sub>	±15%	20	100	-
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	±15%	-	750	mV

1. Whichever is greater, referred to the initial value.

# 2.6 <u>INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS</u>

Unless otherwise specified, the measurements shall be performed at  $T_{amb}$ =+22  $\pm 3^{\circ}$ C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The limit values for each characteristic shall not be exceeded.

Characteristics	Symbols	Limits		Units
		Min	Max	
Collector-Emitter Cut-off Current	I <sub>CEO</sub>	-	10	mA
Forward-Current Transfer Ratio 2	h <sub>FE2</sub>	20	100	-
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	-	750	mV

# 2.7 <u>POWER BURN-IN CONDITIONS</u>

Characteristics	Symbols	Conditions	Units
Case Temperature	T <sub>case</sub>	+100 (+0 -5)	°C
Power Dissipation	P <sub>tot</sub>	As per Maximum Ratings, P <sub>tot</sub> derated at the specified T <sub>case</sub>	W
Collector-Base Voltage	V <sub>CB</sub>	20	V

### 2.8 OPERATING LIFE CONDITIONS

The conditions shall be as specified for Power Burn-in.



ISSUE 2

# **APPENDIX 'A'**

# AGREED DEVIATIONS FOR STMICROELECTRONICS (F)

ITEMS AFFECTED	DESCRIPTION OF DEVIATIONS
Deviations from Room Temperature Electrical Measurements	All AC characteristics (Room Temperature Electrical Measurement Note 2) may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes AC characteristic measurements per the Detail Specification.  A summary of the pilot lot testing shall be provided if required by the Purchase Order.
Deviations from High and Low Temperatures Electrical Measurements	All characteristics specified may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes characteristic measurements at high and low temperatures per the Detail Specification.  A summary of the pilot lot testing shall be provided if required by the Purchase Order.